

**II. Amendments to the Abstract of the Disclosure**

A method for making a multi-layer circuit board 116 having apertures 96, 98 which may be that are selectively and electrically isolated from electrically grounded member 46 and further having selectively formed air bridges and/or crossover members 404 which are structurally supported by a polymeric material 442. Each of the apertures 96, 98 selectively receives an electrically conductive material 444.

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I.B. Patel

Examiner

Art Unit: 2841.

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